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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Complete if Known

Application Number	10/572,753
Confirmation Number	
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First Named Inventor	Hajime NAKAMURA et al.
Art Unit	
Examiner Name	
Attorney Docket Number	062281

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U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	Document Number		Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
		Number	Kind Code ² (if known)		
		US			
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FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	Foreign Patent Document			Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Translation ⁶
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NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation ⁶
/M.H./	1	The Journal of the Institute of Electrical Engineers of Japan, vol. 124, 2004, pages 699-702, published on November 1, 2004.	Yes
/M.H./	2	Press Release (Shin-Etsu News) dated on March 24, 2005.	Yes
/M.H./	3	INTERMAG ASIA 2005; Digest of the IEEE International Magnetism Conference; page 476; held on April 4-8, 2005.	
/M.H./	4	TECHNO-FRONTIER SYMPOSIUM 2005; pages B1-2-1 to B1-2-12; held on April 20, 2005 by JMA.	Yes
/M.H./	5	IEEE TRANSACTIONS ON MAGNETICS, vol. 41, no. 10. October 2005, pages 3844-3846.	
/M.H./	6	Abstract of Autumn Meeting of Japan Society of Powder and Powder Metallurgy, 2005; page 143; held on November 14-16, 2005.	Yes
/M.H./	7	2005 BM SYMPOSIUM, ABSTRACT OF PRESENTATION by THE JAPAN ASSOCIATION OF BONDED MAGNET INDUSTRIES held on December 2, 2005.	Yes

Examiner Signature	/Matthew Hoban/	Date Considered	10/08/2008
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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